

## APPLIED SCIENCES AND ENGINEERING

# High-performance wearable thermoelectric generator with self-healing, recycling, and Lego-like reconfiguring capabilities

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Thermoelectric generators (TEGs) are an excellent candidate for powering wearable electronics and the “Internet of Things,” due to their capability of directly converting heat to electrical energy. Here, we report a high-performance wearable TEG with superior stretchability, self-healability, recyclability, and Lego-like reconfigurability, by combining modular thermoelectric chips, dynamic covalent polyimine, and flowable liquid-metal electrical wiring in a mechanical architecture design of “soft motherboard-rigid plugin modules.” A record-high open-circuit voltage among flexible TEGs is achieved, reaching 1 V/cm<sup>2</sup> at a temperature difference of 95 K. Furthermore, this TEG is integrated with a wavelength-selective metamaterial film on the cold side, leading to greatly improved device performance under solar irradiation, which is critically important for wearable energy harvesting during outdoor activities. The optimal properties and design concepts of TEGs reported here can pave the way for delivering the next-generation high-performance, adaptable, customizable, durable, economical, and eco-friendly energy-harvesting devices with wide applications.

## INTRODUCTION

Thermoelectric generators (TEGs) can directly convert low-grade heat to electricity and, thus, are very promising energy sources for wearable electronics and “Internet of Things” (1). However, conventional TEGs are rigid and brittle (2–6) and, thus, are not adaptable to the complex geometrical and compliant material properties of the human body. Recently, developing flexible TEG systems has attracted a lot of attention, including using thermoelectric (TE) films (7, 8), thermoelectric bulks (9, 10), printable thermoelectric inks (11–15), thermoelectric fibers (16, 17), and organic thermoelectric materials (18, 19). However, very few studies reported TEGs with good stretchability (7, 17), which is critical to ensure conformal contact with complex geometries of human body for optimal thermoelectric performance (20–28). Inspired by the self-healing capability of the human skin, self-healable electronics has also shown promising potential in wearable electronics for improved reliability and durability (29–34). However, this capability has not been achieved in TEG systems yet.

In this work, we report the first self-healable and recyclable TEG system with superior stretchability and thermoelectric performance. A

record-high open-circuit voltage among flexible TEGs is achieved, reaching 1 V/cm<sup>2</sup> at a temperature difference of 95 K. Furthermore, this TEG system has the Lego-like reconfigurability, allowing users to customize the energy-harvesting device according to thermal and mechanical conditions. These properties are realized by integrating high-performance modular thermoelectric chips, dynamic covalent thermoset polyimine as substrate and encapsulation, and flowable liquid metal as electrical wiring through a novel mechanical architecture design of “soft motherboard-rigid plugin modules” (SOM-RIPs). Last, a wavelength-selective metamaterial film is introduced to the cold side of the TEG to enhance the thermoelectric performance under solar irradiation, which is critically important for wearable energy harvesting during outdoor activities.

## RESULTS

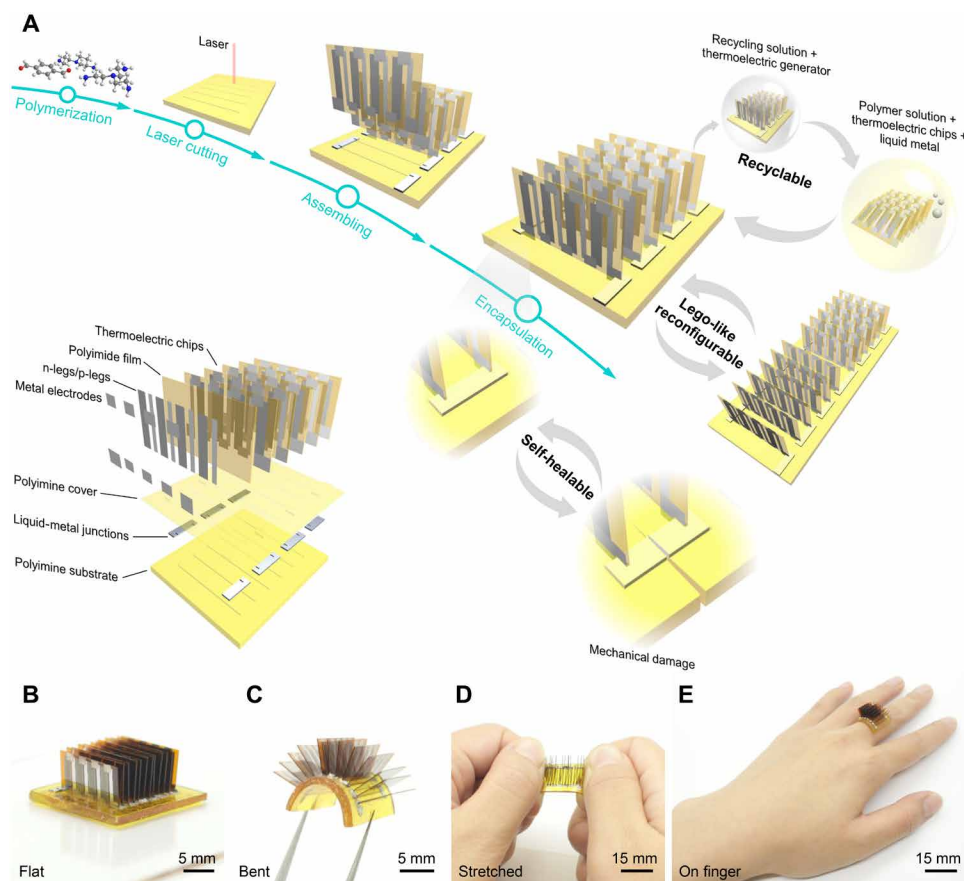
### Device design and fabrication

The TEG is composed of modular thermoelectric chips, liquid metal as electrical wiring, and dynamic covalent thermoset polyimine as both the substrate and encapsulation for liquid-metal wiring (Fig. 1A). Polyimine can be synthesized by cross-linking three commercially available compounds, terephthalaldehyde, 3,3'-diamino-N-methyldipropylamine, and tris(2-aminoethyl)amine (fig. S1) (29, 35, 36). To fabricate the thermoelectric chips, we deposited thin film Bi and Sb chalcogenides onto polyimide films using a thermal evaporator, serving as the n-type legs and p-type legs, respectively (fig. S2). The sizes of n-type legs and p-type legs were determined by a power conversion efficiency optimization process (note S1 and table S1). To improve crystallinity and performance, we then treated the thermoelectric films at 320°C for 26 min in argon atmosphere. Then, Au-Ge electrodes were deposited using a thermal evaporator to form connections between n-type legs and p-type legs, which finishes the fabrication of thermoelectric chips (figs. S2 and S3A). The process of assembling modular thermoelectric chips into TEGs is schematically described in Fig. 1A. It started with laser-cutting a polyimine substrate to create slots (fig. S3B), followed

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**Fig. 1. Design and fabrication of the TEG.** (A) Schematic illustration of the design, fabrication process, and key characteristics, including self-healability, recyclability, and Lego-like reconfigurability. Optical images of the TEG when it is flat (B), bent (C), stretched (D), and worn on the finger (E). Photo credit: Yan Sun, University of Colorado Boulder.

by screen-printing patterned liquid-metal electrical wirings (figs. S3C and S4). Then, the modular thermoelectric chips were inserted into the slots of the polyimide substrate, and a small amount of the polyimide solution [terephthalaldehyde + 3,3'-diamino-*N*-methyldipropylamine + tris(2-aminoethyl)amine in methanol] was applied to bond the thermoelectric chips with the substrate and to encapsulate the liquid-metal wiring. The inset of Fig. 1A presents an exploded view of the device design, and Fig. 1B shows an optical image of the assembled TEG device. Detailed fabrication processes can be found in the Supplementary Materials (note S2 and figs. S2 and S5).

Thanks to the bond exchange reactions within the dynamic covalent thermoset polyimide network and flowability of liquid-metal electrical wiring (29, 36), this TEG is self-healable, recyclable, and Lego-like reconfigurable, as schematically illustrated in Fig. 1A. Furthermore, this TEG has excellent mechanical properties. It can be bent (Fig. 1C), stretched (Fig. 1D), and worn on a finger (Fig. 1E) while functioning.

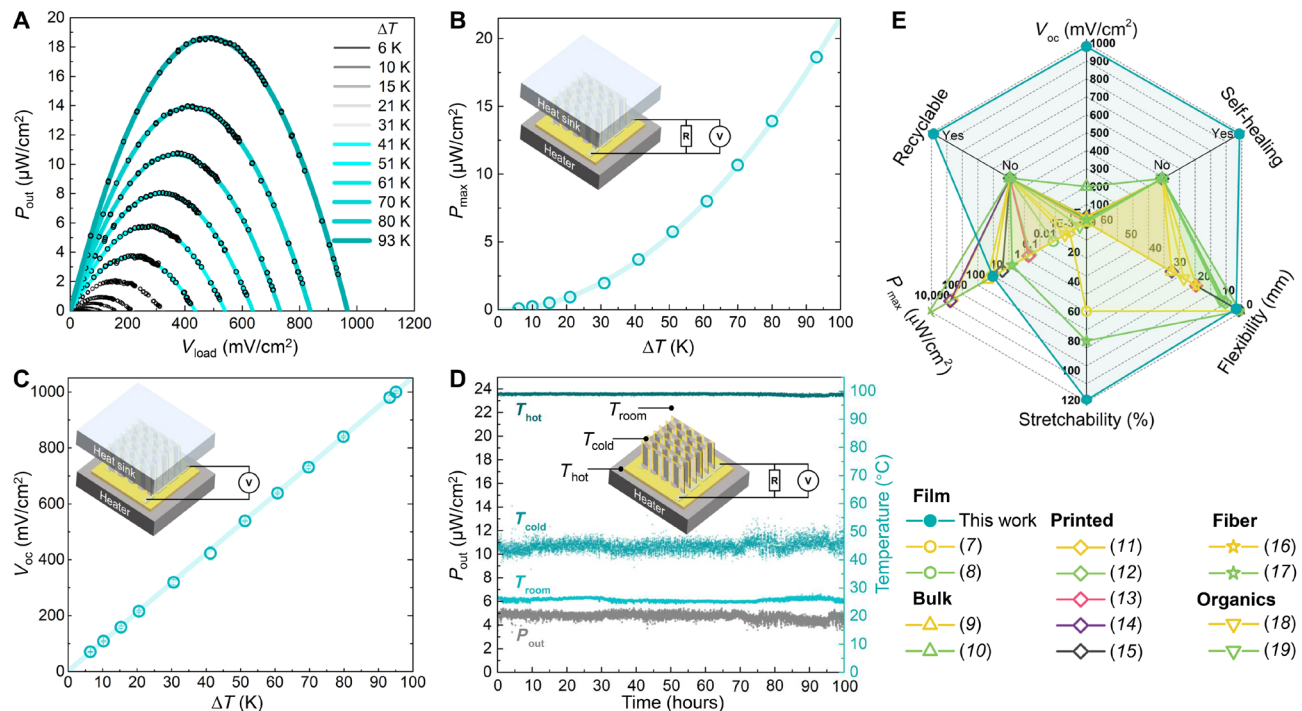
### Power output and thermoelectric endurance

The power and voltage output of the TEG with 112 thermoelectric legs under various temperature differences were tested using a laboratory setup (fig. S6). Figure 2 (A to C) exhibits the power generation ( $P_{\text{out}}$ ) and open-circuit voltage ( $V_{\text{oc}}$ ) per unit area at temperature differences ( $\Delta T$ ) ranging from 6 to 95 K when the cold-side temperature is fixed at 20°C. The relation between power generation

( $P_{\text{out}}$ ) and output voltage ( $V_{\text{load}}$ ) at different temperature differences is given in Fig. 2A. Figure 2B shows that the max power generation  $P_{\text{max}}$  increases with temperature difference  $\Delta T$  and reaches  $19 \mu\text{W}/\text{cm}^2$  at  $\Delta T = 93 \text{ K}$ . The open-circuit voltage per unit area  $V_{\text{oc}}$ , as shown in Fig. 2C, increases linearly with temperature difference and reaches  $1 \text{ V}/\text{cm}^2$  at  $\Delta T = 95 \text{ K}$ , which is remarkably higher than other flexible TEGs reported in literature (7–19). Figure 2D presents the endurance test results of this TEG. The power generation of the TEG remained stable for 100 hours when the hot side was fixed at 100°C and the cold side was subject to indoor natural convection. The results indicate excellent thermal and electrical endurance of this TEG. Figure 2E shows a comparison with flexible TEGs reported in literature on six performance indexes, including max power density, max open-circuit voltage, flexibility (measured in bending radius), stretchability, self-healing, and recyclability (refer to table S2 and fig. S7 for details) (7–19). The TEGs reported here show flexibility and max power density comparable to other flexible TEGs, but the stretchability and max open-circuit voltage are much better. In addition, our TEGs are self-healable, recyclable, and Lego-like reconfigurable (to be demonstrated later), and these properties have not been demonstrated in TEG systems yet.

### Wearable TEG and mechanical properties

This TEG has excellent mechanical flexibility and, thus, can be worn on human body for energy harvesting. Figure 3A shows a TEG



**Fig. 2. Output and endurance of TEGs.** (A) Power generation ( $P_{out}$ ) as a function of output voltage ( $V_{load}$ ) at various temperature differences ( $\Delta T$ ), with the cold-side temperature ( $T_{cold}$ ) kept at 20°C. The black points are measurement data. (B) Maximum power generation ( $P_{max}$ ) versus temperature difference. (C) Open-circuit voltage ( $V_{oc}$ ) versus temperature difference. The solid lines in (A) and (B) are fitting curves using parabolic functions. The solid line in (C) is a linear fitting curve. (D) One hundred-hour endurance test with the hot-side temperature ( $T_{hot}$ ) kept at 100°C. The cold side was natural convection, and the room temperature ( $T_{room}$ ) was around 26°C. (E) Performance comparison between this TEG and other flexible TEGs reported in the literature (see the Supplementary Materials for details). Flexibility refers to the minimum bending radius of TEGs experimentally demonstrated in the literature.

attached on a forearm at a room temperature of 25°C, and the inset gives the infrared measurement of temperature distribution across the device. Figure 3B shows that this TEG device can generate an average power output density of 45 and 83  $nW/cm^2$  and an average output voltage of 25 and 33  $mV/cm^2$  when the wearer was sitting and walking, respectively (fig. S8). For the surface area of a typical sports wristband (6 cm by 25 cm), a power output of 12.5  $\mu W$  and a voltage output of 5 V can be generated when the wearer is walking, which is enough to directly drive most low-power sensor nodes with radio frequency communication.

For wearable devices, the mechanical properties are of paramount importance. To improve the mechanical flexibility and stretchability of the TEG, we introduce an innovative design of SOM-RIPs. This design can effectively separate the rigid and fragile TEG chips from the strains in the soft polyimide substrate during mechanical deformation. Finite element method (FEM) simulation results, as shown in Fig. 3 (C and D), prove the effectiveness of this SOM-RIP design on improving the mechanical properties of the TEG. Figure 3C exhibits the max principal strain distribution contour in the TEG when it is bent to a radius of 3.5 mm. The inset gives the maximum strain in the TE legs to be 0.0003%. Figure 3D shows the max principal strain distribution contour in the TEG when it is stretched by 120%. From the inset, the maximum strain in the thermoelectric legs is only 0.1%, which is below the fracture strain ( $\approx 0.15\%$ ) (37) of TE materials. This SOM-RIP design yields a strain reduction ratio of 1200 times. The strain distribution contours in polyimide and Au-Ge due to bending and stretching are given in fig. S9.

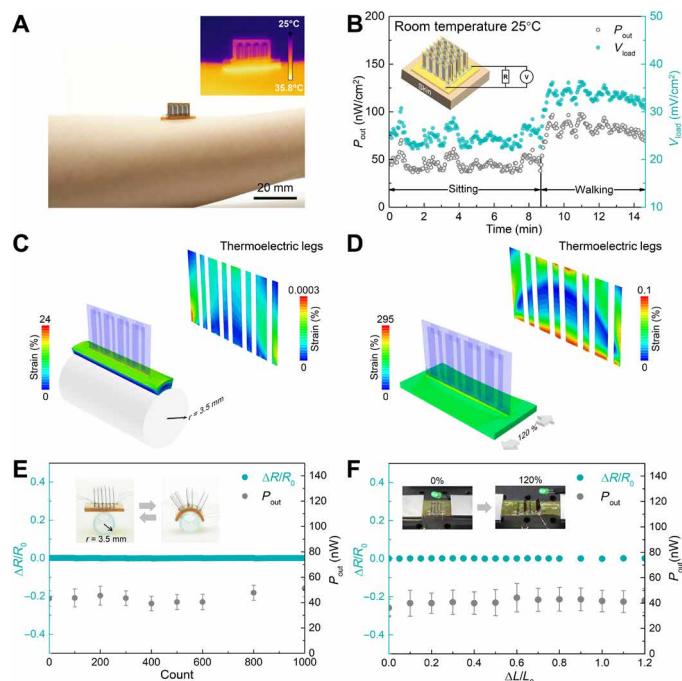
To ensure mechanical robustness, we conducted cyclic bending test, with a bending radius of 3.5 mm. As shown in Fig. 3E and fig. S10, the electrical resistance remains constant, and the power output does not show obvious variation. Figure 3F presents the relative resistance change and power output versus mechanical stretching strain. Both resistance and power output show no noticeable change when the TEG device is stretched by up to 120%. This is also demonstrated by the inset, as the brightness of the light-emitting diode (LED) when it is stretched by 120% is comparable to that when the TEG is not stretched (fig. S11).

It is worth pointing out that the flexibility and stretchability of this TEG are **limited along the direction parallel to the thermoelectric chips**. However, TEGs with ultrahigh flexibility and stretchability along one direction are well suited for cylindrical heat sources, such as arms, legs, and fingers for wearable applications and industrial pipelines for waste heat harvesting.

### Self-healing, recycling, and Lego-like reconfiguration

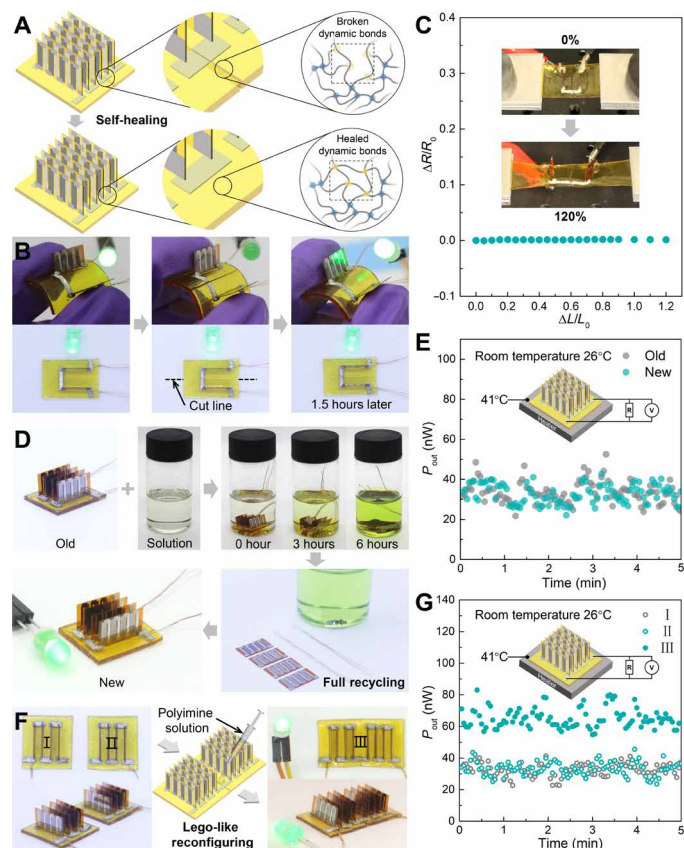
In this TEG, the flowability of liquid-metal wiring and bond exchange reactions within the polyimide network provide excellent self-healing capability to the device (29). Figure 4A schematically illustrates the self-healing process and mechanism. After the liquid-metal wiring and polyimide substrate are cut broken (Fig. 4A, top), the broken interfaces can be brought back in contact. The liquid-metal wiring immediately regains electrical conductivity, due to its fluid-like behavior. Bond exchange reactions promote the generation of new covalent bonds at the interface, leading to a healed TEG





device with both mechanical robustness and electrical functionality (Fig. 4A, bottom). Figure 4B and movie S1 experimentally demonstrate this process using a TEG device with two thermoelectric modules. When the liquid-metal wiring and polyimine substrate are cut broken, the LED turns off (top middle). Bringing the interfaces back to contact leads to immediate healing of the electrical conductivity in the liquid-metal wiring, and the LED turns on again (bottom middle). After 1.5-hour healing at room temperature, sufficient covalent bonds are created at the interface, leading to a mechanically robust self-healed TEG that can be bent without affecting power output (Fig. 4B, right). Optical microscope images in fig. S12 exhibit the healing process of a cut in polyimine over time. The self-healed TEG demonstrates stretchability comparable to the original device, as it can be stretched by 120% without affecting the electrical resistance (Fig. 4C).

Excessive amine monomers can cause depolymerization of polyimine networks into monomers and oligomers soluble in organic solvents, leading to excellent recyclability of polyimine-based devices (29). Figure 4D shows the recycling process of a TEG device. An old TEG



is soaked in the recycling solution [3,3'-diamino-*N*-methylpropylamine and tris(2-aminoethyl)amine in methanol] (top left). After 6 hours at room temperature, the polyimine substrate completely depolymerizes into oligomers and monomers that are soluble in methanol (top right). Then, the other components including thermoelectric modules, conductors, and liquid metal can be separated from the chemical solution (bottom right). The recycled solution can be fully reused to synthesize a new polyimine film by proportionally adding terephthalaldehyde and methanol. A new functional TEG can be fabricated using all components recycled from the old TEG (bottom left). As demonstrated in Fig. 4E, the power output of the new TEG is comparable to the old TEG.

This TEG device is not only self-healable and recyclable but also Lego-like reconfigurable, thanks to the SOM-RIP construction that combines dynamic covalent thermoset polyimine and liquid-metal wiring. Figure 4F demonstrates the reconfiguration of two separate TEG devices (devices I and II) into a new TEG device (device III). The Lego-like reconfiguration process starts with cutting off one terminal of devices I and II to expose the liquid-metal wiring (Fig. 4F, left), followed by bringing the exposed terminals of the two TEGs into physical contact. Then, applying and curing a small amount of polyimine solution [terephthalaldehyde + 3,3'-diamino-*N*-methylpropylamine + tris(2-aminoethyl)amine in methanol] at the joint of the two TEGs completely heal the interface (Fig. 4F, middle). The new TEG is fully functional (Fig. 4F, right). This process is schematically illustrated in detail in fig. S13. As shown in Fig. 4G, the power output of the device III is equal to the sum of devices I and II, indicating that the Lego-like reconfiguring process is effective without performance degradation. Note that during this reconfiguration process, it is not necessary to apply polyimine solution, but more time is required for generating enough covalent bonds at the joint interface. The Lego-like reconfiguration capability allows users to customize TEGs using modules in series or parallel for targeted form factors, constructions, output voltage, and power based on specific thermal conditions and output of thermoelectric chips (fig. S14). The Lego-like reconfigurable TEG can also be integrated into a sensor system based on similar self-healing substrate to form a self-powered autonomous sensor system.

### Enhancing outdoor performance of TEG with metamaterial film

The solar irradiance, ambient radiation, and nonradiative heat exchange can affect the wearable TEG performance during outdoor activities (Fig. 5A, top). The energy balance of the TEG's cold side that is exposed to the ambient can be expressed as (38)

$$Q_{\text{surf}} = P_{\text{nonrad}} + P_{\text{rad}} - P_{\text{abs}} = h_c(T_c - T_{\text{amb}}) + \kappa_B \bar{\epsilon}_{\text{emit}}(T_c^4 - T_s^4) - P_{\text{solar}} \bar{\epsilon}_{\text{abs}} \quad (1)$$

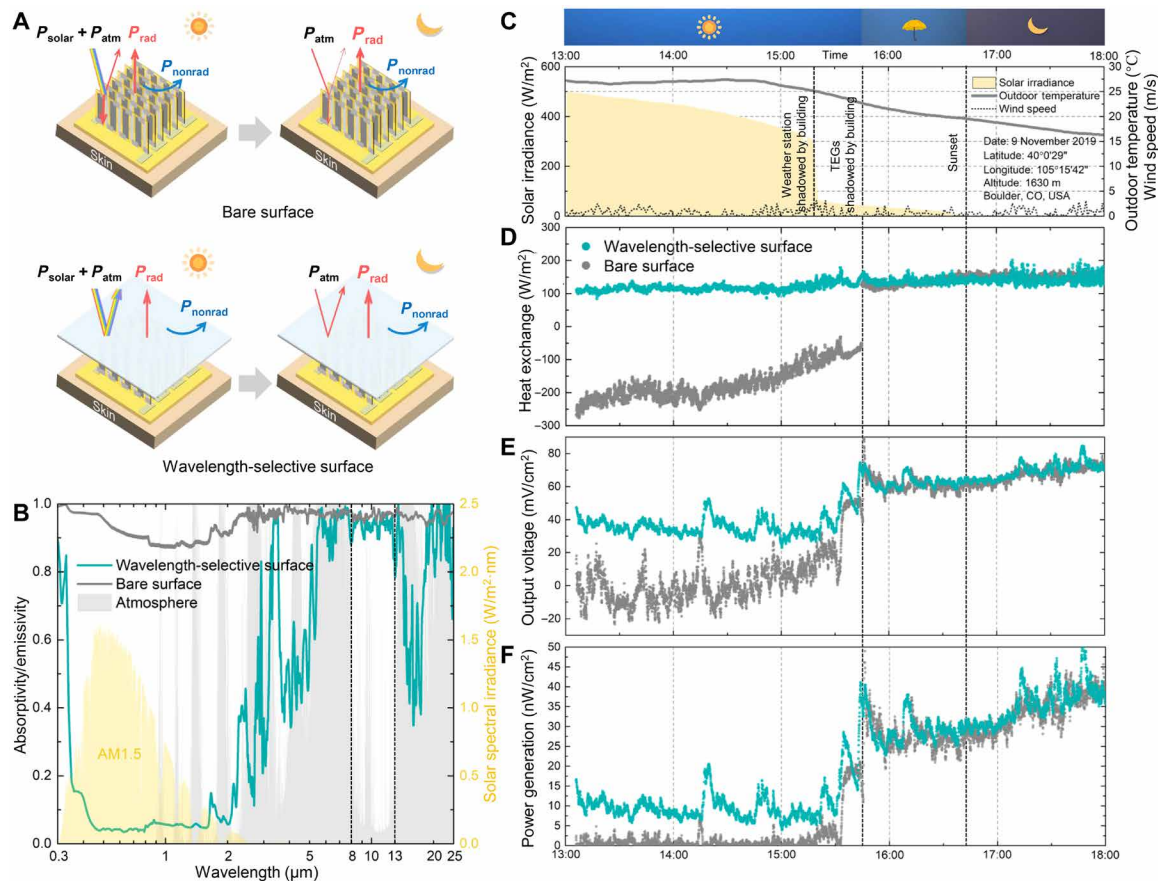
where  $Q_{\text{surf}}$  is the total heat flow on the cold-side surface per unit area,  $P_{\text{nonrad}}$  and  $P_{\text{rad}}$  are the nonradiative heat transfer and thermal radiation exchange per unit area between the cold-side surface and the ambient, respectively,  $P_{\text{abs}}$  is the absorbed solar irradiation power per unit area,  $P_{\text{solar}}$  is the solar irradiation power per unit area, and  $\bar{\epsilon}_{\text{emit}}$  and  $\bar{\epsilon}_{\text{abs}}$  are the effective emissivity and effective absorptivity of the surface, respectively. The emissivity and absorptivity can be used to evaluate the thermal radiation of the cold-side surface and its absorption of the solar irradiation, as shown in Eq. 1. Figure 5B shows the measured wavelength-dependent emissivity/absorptivity of the TEG surface (bare surface). The bare TEG surface has strong absorption ( $>0.87$ ) in the solar spectra (0.3 to 2.5  $\mu\text{m}$ ), indicating that the surface can be heated up by solar irradiance that notably restricts its heat dissipation. To enhance the outdoor TEG performance, the key is to modify the cold-side surface to be wavelength selective for more efficient heat dissipation. This surface must have two characteristics: (i) low absorptivity in the solar spectra and (ii) high emissivity in the infrared range, especially in the atmospheric transmission window (8 to 13  $\mu\text{m}$ ), which allows the cold side to emit infrared radiation to the universe through the atmosphere, namely, radiative sky cooling (38–40). Therefore, a glass-polymer hybrid metamaterial film that can provide both characteristics is chosen and applied as

a cover on the cold-side surface of the TEG (Fig. 5A, bottom), which yields an efficient wavelength-selective surface. As shown in Fig. 5B, the measured wavelength-dependent emissivity/absorptivity of the wavelength-selective surface shows much lower absorption than the bare surface in the solar spectra (0.3 to 2.5  $\mu\text{m}$ ) and comparable emissivity in the atmospheric transmission window (8 to 13  $\mu\text{m}$ ). The detailed design and fabrication of the metamaterial can be found in our previous work (40).

To quantitatively explore the effects of solar irradiance and radiative cooling on thermoelectric performance, we tested TEGs outdoors with both bare surface and wavelength-selective surface at the cold side on a sunny day using a laboratory setup (fig. S15). The measured solar irradiance, outdoor temperature, and wind speed from 13:00 to 18:00 are presented in Fig. 5C. The sudden drop of the measured solar irradiance at 15:18 is because the weather station was shadowed by an adjacent building and the TEG devices were shadowed by the building at 15:45. The heat exchange on the two types of surfaces can be calculated on the basis of the measured data (note S3 and fig. S16). As shown in Fig. 5D, the TEG with bare surface at the cold side has negative heat exchange between 13:00 and 15:45, because the solar absorption on the bare surface is more than the total heat dissipation by radiative and nonradiative heat transfer. This leads to the output voltage of the TEG with bare surface fluctuating around zero (Fig. 5E) and the power generation around only 1  $\text{nW}/\text{cm}^2$  (Fig. 5F) before 15:45. For the TEG with wavelength-selective surface at the cold side, the heat exchange remains stable both before and after the TEG was shadowed by the building, as shown in Fig. 5D. This leads to greatly improved TEG performance with an output voltage of  $\sim 40$   $\text{mV}/\text{cm}^2$  (Fig. 5E) and an output power of  $\sim 10$   $\text{nW}/\text{cm}^2$  (Fig. 5F) before 15:45, when compared with the TEG with bare surface at the cold side. After the TEG devices were shadowed by a building at 15:45, the two TEGs with bare surface and wavelength-selective surface at the cold side have similar total heat exchange and thermoelectric performance, owing to their similar high emissivity in the atmospheric transmission window and the absence of solar irradiation.

### DISCUSSION

A high-performance wearable TEG with superior stretching, self-healing, recycling, and Lego-like reconfiguration capabilities is reported in this work. To achieve these properties, high-performance modular thermoelectric chips, dynamic covalent thermoset polyimine as substrate and encapsulation, and flowable liquid metal as electrical wiring are integrated through a novel mechanical architecture design of SOM-RIPs. This TEG can produce a record-high open-circuit voltage density of 1  $\text{V}/\text{cm}^2$  at a temperature difference of 95 K among flexible TEGs, which is promising for harvesting low-grade heat to power Internet of Things and wearable electronics. These features enable TEGs to be adaptable to the rapidly changing mechanical and thermal conditions and user requirements. Furthermore, a wavelength-selective metamaterial film is integrated at the cold side of the TEG to simultaneously maximize the radiative cooling and minimize the absorption of solar irradiation. Therefore, the thermoelectric performance can be greatly enhanced under solar irradiation, which is critically important for wearable energy harvesting during outdoor activities. The design concepts, approaches, and properties of the TEG system reported in this work can pave the way for delivering the next-generation high-performance, adaptable, customizable, durable, economical, and eco-friendly energy-harvesting devices with wide applications.



**Fig. 5. Outdoor performance enhancement with wavelength-selective metamaterial films.** (A) Schematic illustration of heat-transfer processes of TEGs with bare surface (top) and wavelength-selective surface (bottom) during the daytime and nighttime.  $P_{\text{solar}}$  and  $P_{\text{atm}}$  are the solar irradiation power and atmospheric radiation power on the surface, respectively,  $P_{\text{rad}}$  is the thermal radiation power from the surface, and  $P_{\text{nonrad}}$  is the nonradiative heat transfer (convection and conduction) between the surface and ambient. (B) Measured absorptivity/emissivity of the bare surface and wavelength-selective surface from 300 nm to 25  $\mu\text{m}$ . The absorptivity/emissivity of the atmosphere (gray block) and power density of spectral solar irradiance [yellow block; air mass (AM), 1.5] are also included. Both bare surface and wavelength-selective surface have strong emission between 8 and 13  $\mu\text{m}$  (atmospheric transmission window), indicating excellent radiative cooling performance. The bare surface has strong absorption at full solar spectrum ( $>0.87$ ) and other infrared bands ( $>0.96$ ), while the wavelength-selective surface has much weaker absorption at solar spectrum than at infrared bands. (C) Solar irradiance, outdoor temperature, and wind speed measured by a weather station from 13:00 to 18:00 (9 November 2019, Boulder, CO, USA). Total surface heat exchange (D), output voltage (E), and power generation (F) of the TEGs with bare surface and wavelength-selective surface at the cold side from 13:00 to 18:00.

Note also that the overall design concept of this work is scalable and adaptable to other thermoelectric materials and fabrication methods, including roll-to-roll physical vapor deposition and printing techniques (41). It is possible to further enhance the thermoelectric performance of the wearable TEG, by improving fabrication process of thermoelectric films, adopting thermoelectric films with better thermoelectric properties (42–45), and using traditional thermoelectric legs with much smaller dimensions.

## MATERIALS AND METHODS

### Material synthesis and device fabrication

Thin-film thermoelectric materials were deposited on a polyimide film (125  $\mu\text{m}$ ; DuPont) by a thermal evaporator. The target materials of p-type legs and n-type legs for the evaporation were  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  and  $\text{Bi}_2\text{Te}_{2.8}\text{Se}_{0.3}$  bulks, respectively, which were prepared by smelting Bi ingot (99.999%; Alfa Aesar), Sb ingot (99.999%; Alfa Aesar), Te ingot (99.999%; Alfa Aesar), and Se ingot (99.999%; Alfa Aesar) in sealed quartz tubes under vacuum below  $10^{-3}$  Pa using a muffle

furnace (KSL-1100X-L) at 1073 K for 5 hours. The deposited thermoelectric films were then heated at 320 $^{\circ}\text{C}$  for 26 min in argon atmosphere using a tube furnace (OTF-1200X). Au-Ge thin-film electrodes were deposited by a thermal evaporator using  $\text{Au}_{88}\text{Ge}_{12}$  alloy (99.99%; Kurt. J. Lesker) as the target material. The polyimide substrate is polymerized using three commercial compounds, terephthalaldehyde, 3,3'-diamino-N-methyldipropylamine, and tris(2-aminoethyl)amine. A mixture of 3,3'-diamino-N-methyldipropylamine (1.251 g, 8.61 mmol) and tris(2-aminoethyl)amine (0.252 g, 1.72 mmol) was added to a 25-ml centrifuge tube with a screw cap, followed by addition of methanol (20 ml) and terephthalaldehyde (1.5 g, 11.18 mmol). The mixture was stirred until the solution became translucent and yellow in color, and then the solution was poured into petri dish coated with polydimethylsiloxane. The solution was cured by evaporative drying in a fume hood for at least 72 hours at room temperature. The recycling solution is a mixture of 3,3'-diamino-N-methyldipropylamine (1.251 g, 8.61 mmol) and tris(2-aminoethyl)amine (0.252 g, 1.72 mmol) in methanol. The liquid metal (a mixture of 75.5% gallium and 24.5% indium by weight) was blended with 0.35 weight %  $\text{SiO}_2$  particles



(radius, 40  $\mu\text{m}$ ) to improve screen-printing yield. The melting point of the liquid metal is 15.3°C. Alternatively, eutectic gallium-indium-tin (galinstan) (68% Ga, 22% In, and 10% Sn by weight) with a melting point of −19°C can be adopted for a colder environment. A laser cutting device (Epilog 36EXT Model 9000) was used to prepare all the masks and slots in polyimide substrates. The wavelength-selective film was attached on the cold side of the TEG using a pressure-sensitive tape.

### Materials characterization

The thicknesses of the thermoelectric films and Au-Ge film was measured by a stylus profiler (Bruker DektakXT). The surface microtopography and composition were analyzed using scanning electronic microscope (Quanta 200 FEG and Hitachi SU3500) accompanied by the energy-dispersive x-ray spectroscopy. The Seebeck coefficient and electrical resistivity were measured by the four-probe method on a simultaneous measurement system (ULVAC ZEM-3), and the thermal conductivity of the thermoelectric films (fig. S17) was measured by the time-domain thermoreflectance method (46) on a homemade system (table S1 and figs. S18 and S19). Optical microscope images of the self-healing process were obtained using a super depth of field digital microscope (KEYENCE VHX-1000E).

### TEG output measurement

The indoor and outdoor performances of TEG were tested by homemade setups (figs. S6 and S15). The hot side is a temperature-controlled heating table. The cold side is a double-stage cooler (hydrocooling and Peltier cooler) that can accurately control the cold-side temperature of TEG from 0°C to room temperature. Type T thermocouples (wire diameter, 0.127 mm; OMEGA TT-T-36) were used to test the cold- and hot-side temperatures of TEG. The thermocouple wires were fixed by holders beside the tested positions, and only the bare tips of the thermocouples closely touched the tested positions by the elasticity of the thermocouple wires to avoid extra heat loss. No grease, glue, tape, or clamp was used to fix the thermocouples. Room temperature was measured by a type T thermocouple placed in air near the TEG. All the data including the temperature, voltage, and resistance were collected by a multi-functional data collector (Keysight 34970A). Infrared images were obtained by an infrared camera (FLIR T630sc). Solar irradiance, outdoor temperature, and wind speed were tested by a weather station near the TEG.

### Mechanical characterization

The stretch tests were carried on a homemade stretching equipment. Simulated strain distribution contours in the TEG were obtained using a commercial software Abaqus. The AuGe conductive layer was modeled as skin layer on the surface of the polyimide film and thermoelectric legs and then meshed by four-node shell elements. The polyimide film, p-type and n-type thermoelectric legs, and polyimide substrate were modeled using eight-node solid elements. The elastic moduli of the AuGe, n-type legs, p-type legs, polyimide films, and polyimide substrate were 69.2 GPa, 52 GPa, 46 GPa, 2.5 GPa, and 2 MPa, respectively. The Poisson's ratios for them were 0.32, 0.25, 0.25, 0.34, and 0.35, respectively. A strain of 120% and a bending radius of 3.5 mm were separately applied to the model to simulate experimental conditions.

### SUPPLEMENTARY MATERIALS

Supplementary material for this article is available at <http://advances.sciencemag.org/cgi/content/full/7/7/eabe0586/DC1>

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#### Acknowledgments

**Funding:** We acknowledge financial supports from the NSF, USA (CMMI-1762324) and the National Key R&D Program of China (2019YFA0705201). D.Z. acknowledges the support from the Natural Science Foundation of Jiangsu Province, China (BK20200373). **Author contributions:** W.R., Y.S., D.Z., L.Z., J.X., and R.Y. conceived and designed the experiment. W.R. and Y.S. fabricated TEGs and performed the mechanical test and indoor output test. W.R., Y.S., D.Z., and A.A. conducted the outdoor test of TEGs. W.R., Y.S., and Jie Zhang measured and characterized the TE films and modified liquid metal and polyimide. S.Z. performed FEM simulations. Y.S. and C.S. fabricated the polyimide. W.R., Jialun Zhang, and H.G. designed and fabricated the TE material targets. W.R., Y.S., D.Z., A.A., L.Z., J.X., and R.Y. analyzed the experimental data. W.R., Y.S., D.Z., L.Z., J.X., and R.Y. wrote the paper. All authors discussed the results and commented on the manuscript. **Competing interests:** The authors declare that they have no competing interests. **Data and materials availability:** All data needed to evaluate the conclusions in the paper are present in the paper and/or the Supplementary Materials. Additional data related to this paper may be requested from the authors.

Submitted 28 July 2020

Accepted 21 December 2020

Published 10 February 2021

10.1126/sciadv.abe0586

**Citation:** W. Ren, Y. Sun, D. Zhao, A. Aili, S. Zhang, C. Shi, J. Zhang, H. Geng, J. Zhang, L. Zhang, J. Xiao, R. Yang, High-performance wearable thermoelectric generator with self-healing, recycling, and Lego-like reconfiguring capabilities. *Sci. Adv.* **7**, eaab0586 (2021).



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*Sci. Adv.*, 7 (7), eabe0586. • DOI: 10.1126/sciadv.abe0586

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